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High aspect ratio surface relief structures by photoembossing

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Photoembossing is a convenient and economical process to form complex surface relief structures in polymer thin films. We have improved the aspect ratio of photoembossed microstructures by adding tert-butyl hydroquinone (TBHQ) to the polymerization mixture. The mechanism that is proposed is based on the radical transfer principle, where TBHQ converts acrylate radicals into stable phenol radicals that at elevated temperatures act as latent initiators, thereby controlling the kinetics without changing the number of polymerization active sites. As a result, the aspect ratio can be improved with a factor of 5–7 in comparison with previously proposed similar processes. © 2007 American Institute of Physics. [DOI: 10.1063/1.2799744]

Photoembossing is a promising new technique for creating surface relief structures. This technique is based on a photopolymer that in its most simple form consists of a polymeric binder, a multifunctional monomer, and a photoinitiator. This mixture is processed from the solution to form a solid thin film on a substrate. A relief structure is created into the photopolymer by a simple two step procedure. First, a patterned ultraviolet (UV) exposure is applied to the photopolymer to create a latent image. Second, the sample is heated causing a reaction driven diffusion of reactive species to the exposed areas and the development of the surface relief structure. In a final processing step, the sample is fully polymerized by applying a flood exposure. Unlike conventional patterning techniques, such as hot embossing or photolithography, photoembossing does not require expensive moulds or contact with aggressive etching fluids or solvents. Combined with the ease of processing, photoembossing is a convenient and economical process to form complex surface relief structures in polymer thin films. A schematic representation of the photoembossing process is given in Fig. 1.

In order to expand the range of applications and to be more competitive with other technologies, it is the objective of our research to increase the aspect ratio of the surface relief structures. In current photoembossing, the aspect ratio, defined as the ratio of height and width, is typically less than 1/20 for a 40 μm periodic line structure.

It was found that the material flux, and thus the aspect ratio, is highly affected by the polymerization kinetics and can be optimized by changing the rate of initiation via altering initiator content or light intensity. It is the objective of our present research to improve the aspect ratio even further. In this paper, we improved on the aspect ratio by tailoring the kinetics using the addition of tert-butyl hydroquinone (TBHQ), which is a well-known inhibitor and/or retarder.

For the photopolymer polybenzylmethacrylate (Mn, 70 kg mol⁻¹, Scientific Polymer Products) was used as a polymeric binder, dipentaerythritol penta-/hexa-acrylate (Sigma Aldrich) as a multifunctional monomer, and Irgacure 819 (CIBA, Specialty Chemicals) as a photoinitiator. As a solvent, a 50/50 wt % mixture of ethoxypropylacetate (Avocado Research Chemicals) and propylene glycol methyl ether acetate (Aldrich) was used. To prepare the photopolymer solutions, the multifunctional monomer and the solvent were mixed in a weight ratio of 1:2, and the the 500 ppm of 4-methoxyphenol present in the monomer was removed using silica packed inhibitor removing column (Aldrich). The monomer/solvent mixture was mixed with the polymer and photoinitiator in a weight ratio of respectively 30:10:1, and TBHQ (Aldrich) was added in different concentrations to the photopolymer solution.

The photopolymer solution was spincoated on top of cleaned glass substrates and subsequently dried at 80 °C for 20 min, resulting in dry films with a thickness of approximately 16 μm. Next, the samples were UV mask exposed using a line mask with a 40 μm periodicity in direct contact with the sample. After exposure the mask was removed and the sample was gradually heated to a temperature of 110 °C

[FIG. 1. (Color) Schematic representation of the photoembossing process.]
and kept for 10 min at this temperature before applying a flood exposure to fully polymerize the photopolymer. To prevent oxygen inhibition during exposure, development, and flood exposure, the samples were placed under a protective atmosphere by constant nitrogen blanketing.

The resulting structure heights were measured with a mechanical profilometer from Tencor Instruments (Alpha-Step 200), which was equipped with a stylus with a 2 μm radius and a 45° tip angle.

We first studied the effect of TBHQ on the polymerization kinetics by means of real time attenuated total reflection infrared spectroscopy upon UV flood exposure of a solid photopolymer film. Different amounts of 0, 2, 4, and 8 wt % TBHQ were added to the photopolymer. The photopolymerization was initiated 10 s after starting the measurement by continuous exposure to UV light (λ=365 nm and I=1.5 × 10^{-2} J/cm²). The results, which are displayed in Fig. 2(a), clearly show that adding TBHQ reduces the rate of polymerization and no induction period was found. This indicates that TBHQ behaves predominantly as a retarder in the photopolymer system upon photopolymerization.

We subsequently studied the effect of TBHQ on the aspect ratio of photoembossed structures. The results are given in Fig. 2(b). The results show that the aspect ratio increases with increasing amounts of TBHQ up to a maximum, of which the position depends on the exposure dose used during the mask exposure step. Beyond this maximum, the enhanced effect of the TBHQ diminishes again. The extent of increase in aspect ratio is further illustrated by scanning electron microscopy images, which are given in Figs. 2(c)–2(e), of samples containing different concentrations of TBHQ. Much to our surprise, the increase of the height of the structures and their aspect ratio is much larger than what can be achieved by simply reducing the polymerization rate by the reduction of light intensity or initiator concentration alone.

This means that there must be an additional mechanism explaining the enormous effects of TBHQ, which we will try to elucidate in the following paragraphs.

In contrast to decreasing the rate of polymerization by intensity reduction, the presence of TBHQ only temporarily reduces the number of free radicals by capturing them into low-reactive species. However, these species are reactivated again during the heating step where the structures are being formed, thus increasing the concentration of initiating free radicals. Also, in the absence of TBHQ, the dominant “buried” radical species for a multifunctional acrylate are commonly found to be midchain acrylate radicals. Although highly reactive, these radicals have an extreme longevity which is caused by steric effects that prevent any further reactions. Upon the addition of TBHQ, highly reactive acrylate radicals are transferred to the phenolic compound, thus creating the stable radical species, acting as a latent initiator. Upon heating, the enhanced consumption of monomer leads to an increased driving force for diffusion. The formation of the stable phenolic free radical species is further supported by electron spin resonance (ESR) spectra taken from samples with 0 and 8 wt % TBHQ upon exposure to UV light. The results, which are given in Figs. 3(a) and 3(b), show that in the absence of TBHQ, the ESR signal consists of a complex low-reactive species. However, these species are reactivated again during the heating step where the structures are being formed, thus increasing the concentration of initiating free radicals. Also, in the absence of TBHQ, the dominant “buried” radical species for a multifunctional acrylate are commonly found to be midchain acrylate radicals. Although highly reactive, these radicals have an extreme longevity which is caused by steric effects that prevent any further reactions. Upon the addition of TBHQ, highly reactive acrylate radicals are transferred to the phenolic compound, thus creating the stable radical species, acting as a latent initiator. Upon heating, the enhanced consumption of monomer leads to an increased driving force for diffusion. The formation of the stable phenolic free radical species is further supported by electron spin resonance (ESR) spectra taken from samples with 0 and 8 wt % TBHQ upon exposure to UV light. The results, which are given in Figs. 3(a) and 3(b), show that in the absence of TBHQ, the ESR signal consists of a complex low-reactive species. However, these species are reactivated again during the heating step where the structures are being formed, thus increasing the concentration of initiating free radicals. Also, in the absence of TBHQ, the dominant “buried” radical species for a multifunctional acrylate are commonly found to be midchain acrylate radicals.
When the TBHQ concentration becomes too high, the maximum aspect ratio decreases again. We believe that besides the function of latent initiator, it also contributes to the termination of the polymerization reaction. A first indication for this can be obtained from Fig. 2(a), showing that under the same conditions, a higher TBHQ concentration leads to lower end-conversion and thus smaller monomer consumption. Also, as monomer consumption in the exposed areas is the main driving force for diffusion, a reduction in end conversion thus results in less diffusion. This effect can be postponed by choosing a higher exposure dose, increasing the concentration of the initially captured reactive species. It is this balance between the initial concentration of reactive species and the end conversion, or the exposure dose and the TBHQ concentration, that influences the final aspect ratio of the photoembossed structures and explains the observations from Fig. 2(b).

In conclusion, we have shown that by adding TBHQ, the aspect ratio of photoembossed structures in a thin film can be increased with a factor of 5–7. In the absence of environmental oxygen, TBHQ behaves as a retarder in the photopolymer system and reduces the rate polymerization by converting acrylate radicals into stable phenol radicals. It is proposed that the increase in aspect ratio is predominately caused by the formation of stable radicals which can more easily reinitiate the polymerization of diffusing monomer during heat development than the persistent radicals which are formed in the absence of TBHQ.

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